

### NOT RECOMMENDED FOR NEW DESIGN **USE HDS10M**



HD01 - HD06

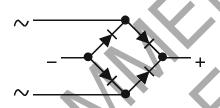
### 0.8A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

### **Features and Benefits**

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Miniature Package Saves Space on PC Boards
- UL Listed Under Recognized Component Index, File Number E94661
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Case: MiniDIP
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Tin. Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Polarity: As Marked on Case
- Marking: Product Type Marking Code, Date Code, & Polarity
- Weight: 0.125 grams (Approximate)



Equivalent Circuit

## Ordering Information (Note 3)

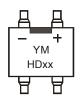
Pa	rt Number*		Packaging	Shipping
	HDxx-T		MiniDIP	3k/Tape & Reel, 13-inch

<sup>\*</sup>xx = Device type, e.g. HD02-T or HD04-T, etc.

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



HDxx = Product Type Marking Code (ex: HD04) YM = Date Code Marking Y = Last Digit of the Year M = See Month/Code Table Below

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	HD01	HD02	HD04	HD06	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RMM</sub> V <sub>RWM</sub> V <sub>DC</sub>	100	200	400	600	<b>\</b>
RMS Reverse Voltage	V <sub>RMS</sub>	70	140	280	420	V
Average Forward Rectified Current (Note 4) @T <sub>A</sub> = +40°C	lo		0	.8		Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>		3	30		Α

# **Thermal Characteristics**

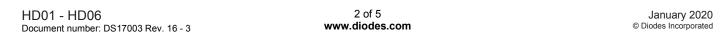
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 4)	$R_{ heta JA}$	75	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

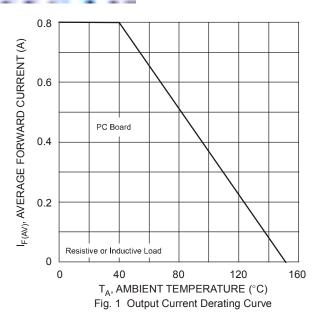
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

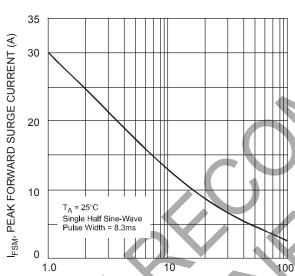
Characteristic	Symbol	Value	Unit
Instantaneous Voltage Drop @ 0.4A (Per Element)	V <sub>F</sub>	1.0	V
Peak Reverse Current at Rated @T <sub>A</sub> = +25°C		5.0	μA
DC Blocking Voltage (Per Element) @T <sub>A</sub> = +125°C	IR	500	μΛ
Typical Total Capacitance (Per Element) (Note 5)	C <sub>T</sub>	10	pF

Notes:

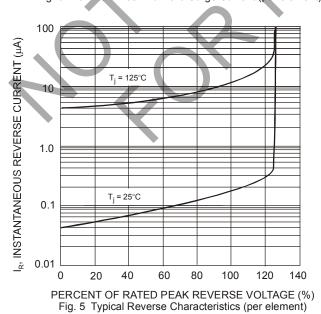
- 4. Mounted on PC Board.
- 5. Measured at 1.0MHz and applied reverse voltage of 4.0V.

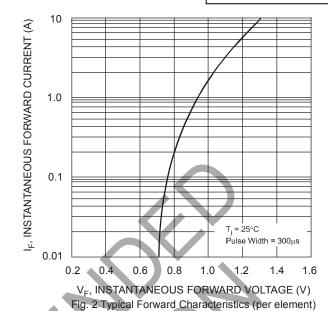






NUMBER OF CYCLES AT 60 Hz Fig. 3 Maximum Peak Forward Surge Current (per element)





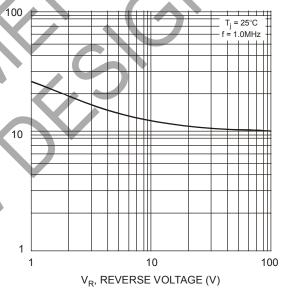


Fig. 4 Typical Total Capacitance (per element)

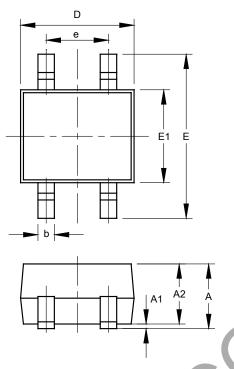
TOTAL CAPACITANCE (pF)

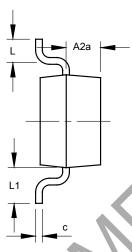


# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **MiniDIP**



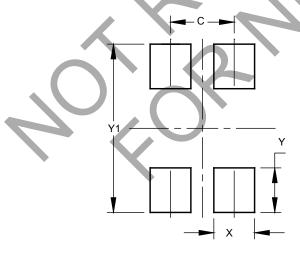


MiniDIP					
Dim	Min	Max			
Α		3.00			
A1		0.20			
A2	2.30	2.70			
A2a	1.20	1.60			
b	0.50	0.80			
С	0.15	0.35			
D	4.50	4.90			
Е	1	7.00			
E1	3.60	4.00			
е	2.30	2.70			
L	0.70	1.10			
L1	1.10	2.12			
All Din	ensions	in mm			

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## MiniDIP



Dimensions	Value (in			
Dillielisiolis	mm)			
С	2.50			
X	1.65			
Υ	1.80			
Y1	6.80			



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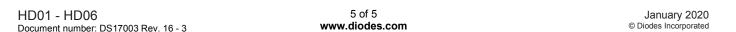
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